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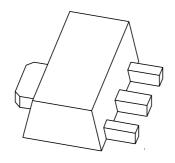
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



PXT4403 PNP switching transistor

Product data sheet Supersedes data of 1999 Apr 14 2004 Nov 22



PNP switching transistor

PXT4403

FEATURES

- High current (max. 600 mA)
- Low voltage (max. 40 V).

APPLICATIONS

• Switching and linear amplification.

DESCRIPTION

PNP switching transistor in a SOT89 plastic package. NPN complement: PXT4401.

MARKING

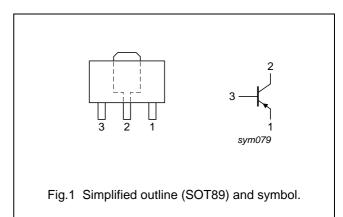
| TYPE NUMBER | MARKING CODE(1) |
|-------------|-----------------|
| PXT4403 | *2T |

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | emitter |
| 2 | collector |
| 3 | base |



ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | | |
|--------------|----------------------|--|-------|--|
| TIPE NOWIBER | NAME DESCRIPTION VEF | | | |
| PXT4403 | SC-62 | plastic surface mounted package; collector pad for good heat transfer; 3 leads | SOT89 | |

PNP switching transistor

PXT4403

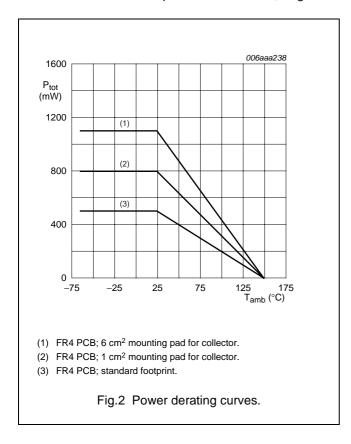
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|---------------------------|--------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | -40 | V |
| V _{CEO} | collector-emitter voltage | open base | _ | -40 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | -5 | V |
| I _C | collector current (DC) | | _ | -600 | mA |
| I _{CM} | peak collector current | | - | -800 | mA |
| I _{BM} | peak base current | | _ | -200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | | | |
| | | note 1 | _ | 0.5 | W |
| | | note 2 | _ | 0.8 | W |
| | | note 3 | _ | 1.1 | W |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².



PNP switching transistor

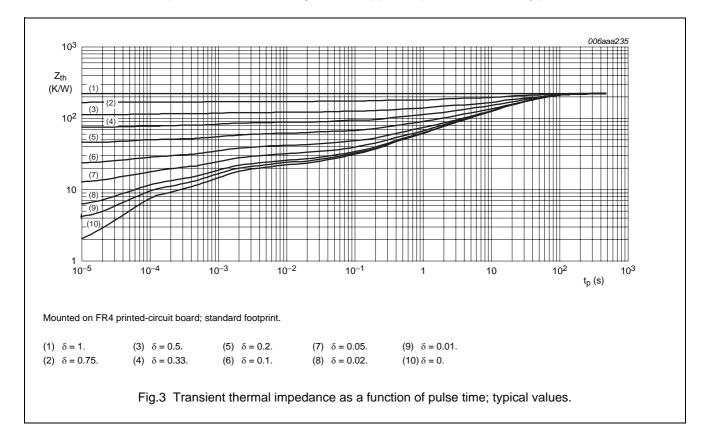
PXT4403

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|-------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to | in free air | | |
| | ambient | note 1 | 250 | K/W |
| | | note 2 | 156 | K/W |
| | | note 3 | 113 | K/W |
| R _{th(j-s)} | thermal resistance from junction to soldering point | | 30 | K/W |

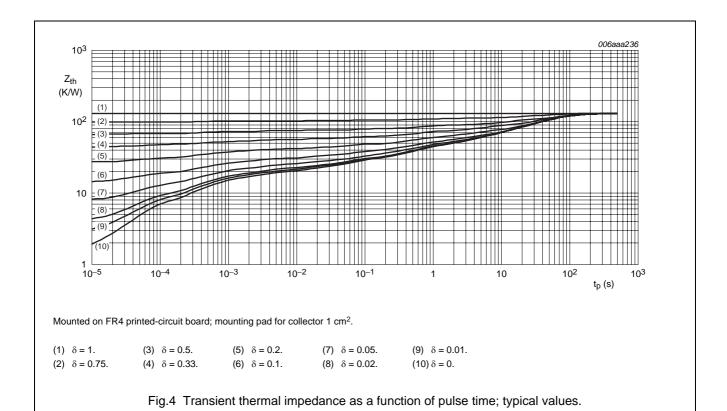
Notes

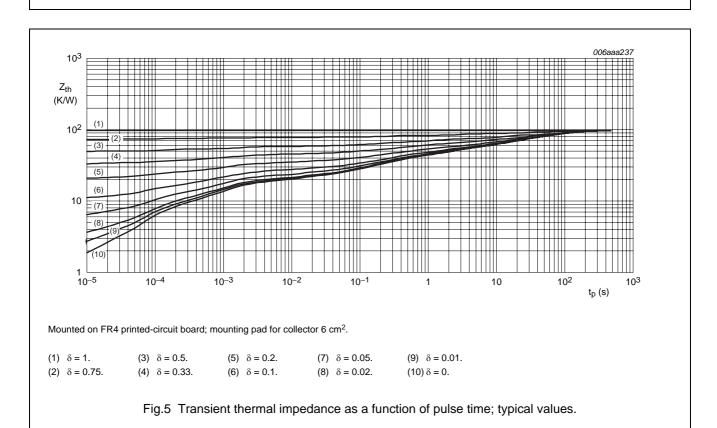
- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².



PNP switching transistor

PXT4403





PNP switching transistor

PXT4403

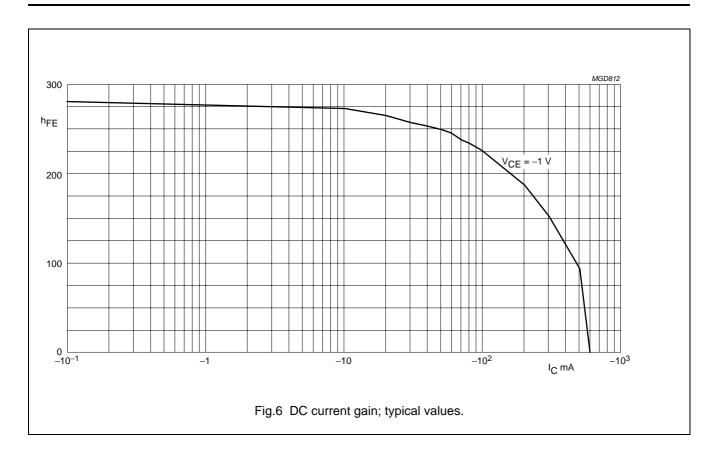
CHARACTERISTICS

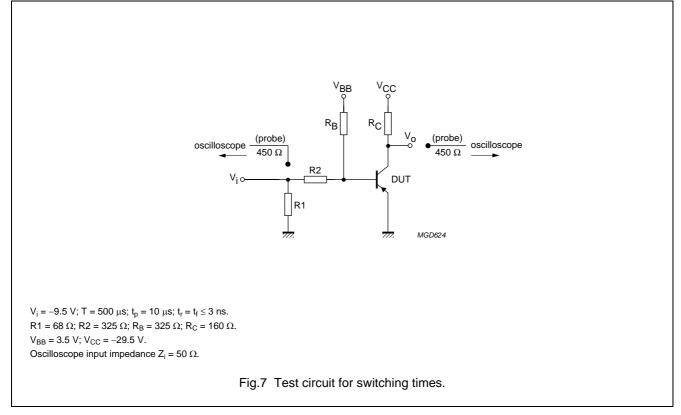
 T_{amb} = 25 °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------------|---|--|------|------|------|
| I _{CBO} | collector-base cut-off current | I _E = 0 A; V _{CB} = -40 V | - | -50 | nA |
| I _{EBO} | emitter-base cut-off current | I _C = 0 A; V _{EB} = -5 V | - | -50 | nA |
| h _{FE} | DC current gain | $I_C = -0.1 \text{ mA}; V_{CE} = -1 \text{ V}$ | 30 | - | |
| | | $I_C = -1 \text{ mA}; V_{CE} = -1 \text{ V}$ | 60 | _ | |
| | | $I_C = -10 \text{ mA}; V_{CE} = -1 \text{ V}$ | 100 | _ | |
| | | $I_C = -150 \text{ mA}; V_{CE} = -2 \text{ V}$ | 100 | 300 | |
| | | $I_C = -500 \text{ mA}; V_{CE} = -2 \text{ V}$ | 20 | _ | |
| V _{CEsat} | collector-emitter saturation | $I_C = -150 \text{ mA}; I_B = -15 \text{ mA}$ | Ī- | -400 | mV |
| | voltage | $I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$ | Ī- | -750 | mV |
| V _{BEsat} | base-emitter saturation voltage | $I_C = -150 \text{ mA}; I_B = -15 \text{ mA}$ | Ī- | -950 | mV |
| | | $I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$ | Ī- | -1.3 | V |
| C _c | collector capacitance | $I_E = i_e = 0 \text{ A}; V_{CB} = -10 \text{ V}; f = 1 \text{ MHz}$ | - | 8.5 | pF |
| C _e | emitter capacitance | $I_C = i_c = 0 \text{ A}; V_{EB} = -500 \text{ mV}; f = 1 \text{ MHz}$ | - | 35 | pF |
| f _T | transition frequency | $I_C = -20 \text{ mA}; V_{CE} = -10 \text{ V}; f = 100 \text{ MHz}$ | 200 | - | MHz |
| Switching t | Switching times (between 10% and 90% levels); (see Fig.7) | | | | |
| t _{on} | turn-on time | $I_{Con} = -150 \text{ mA}; I_{Bon} = -15 \text{ mA};$ | _ | 40 | ns |
| t _d | delay time | I _{Boff} = 15 mA | _ | 15 | ns |
| t _r | rise time | | _ | 30 | ns |
| t _{off} | turn-off time | | _ | 350 | ns |
| t _s | storage time | | _ | 300 | ns |
| t _f | fall time | | _ | 50 | ns |

PNP switching transistor

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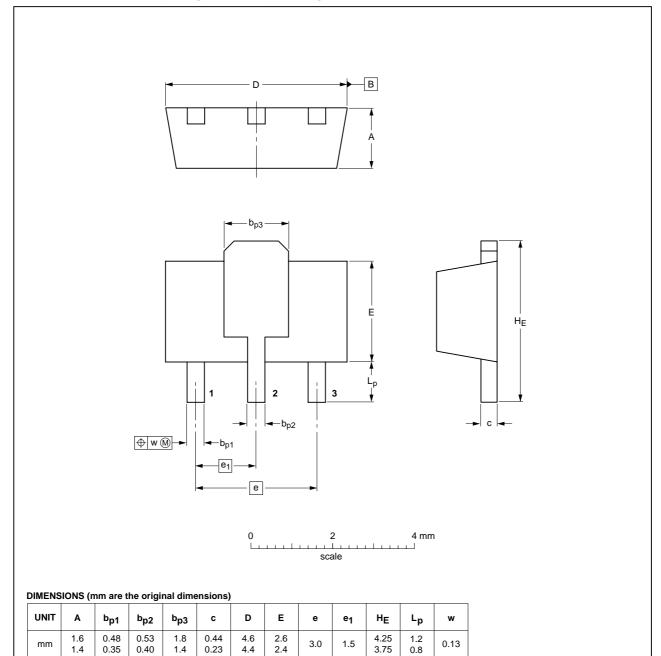
PNP switching transistor

PXT4403

PACKAGE OUTLINE

Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



| OUTLINE | REFERENCES | | EUROPEAN | ISSUE DATE | | |
|---------|------------|--------|----------|------------|------------|----------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT89 | | TO-243 | SC-62 | | | -04-08-03 06-03-16 |

PNP switching transistor

PXT4403

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

Notes

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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